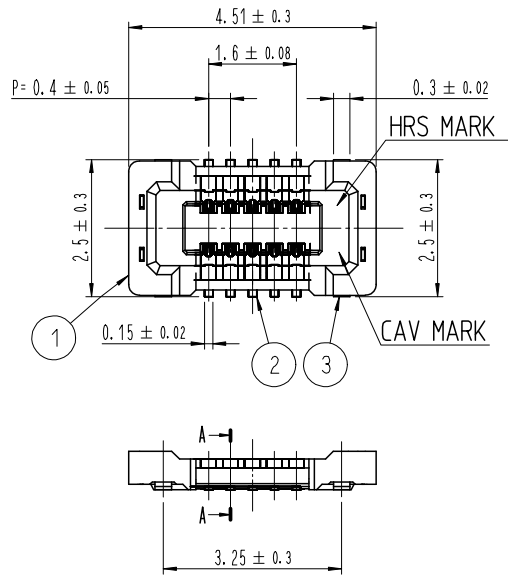
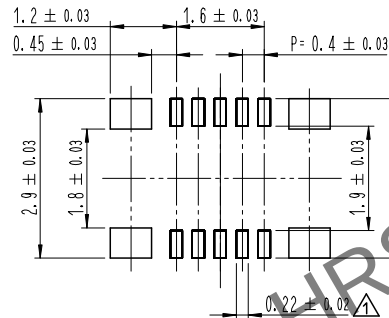




④ RECOMMENDED PATTERN

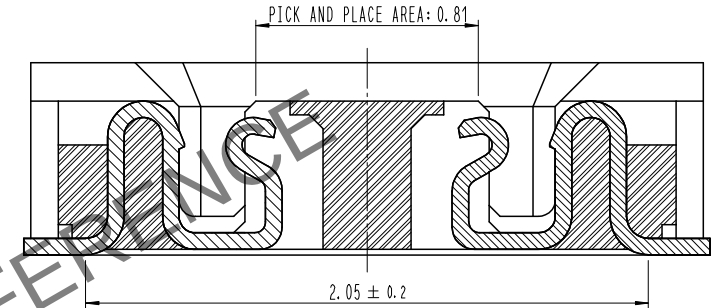


④ RECOMMENDED SOLDER PASTE: THICKNESS 100 μm

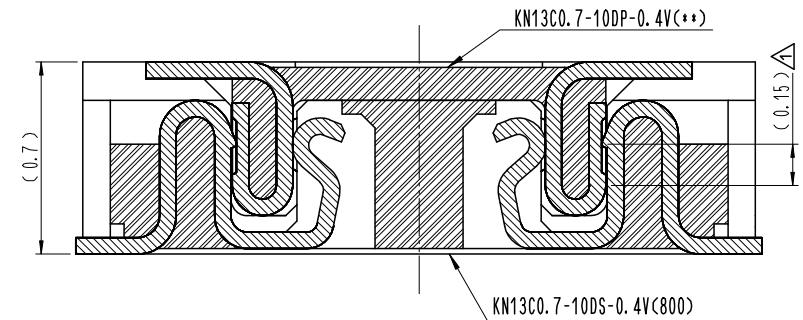
- NOTE
1. ALL LEAD CO-PLANARITY SHALL BE 0.08mm MAX.
 - ②. CONTACT PLATING SPECIFICATIONS.
CONTACT AREA : GOLD 0.05 μm MIN.
SMT LEAD : GOLD 0.05 μm MIN.
UNDER PLATING : NICKEL 1 μm MIN.
(SURFACE : SEALING)
 - ③. METAL HOLD DOWN PLATING SPECIFICATIONS.
SMT LEAD : GOLD 0.05 μm MIN.
UNDER PLATING : NICKEL 1 μm MIN.
 - ④. PLEASE CONTACT US IN CASE YOU WILL MAKE DIFFERENT SETTINGS FROM OUR RECOMMENDATION.

COUNT	DESCRIPTION OF REVISIONS	B	Y	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	B	Y	CHKD	DATE
2	RE-6-0786	JSH	JHW	16. 11. 30							
5	RE-6-1598	JDH	JHW	19. 10. 30							

A:A(50:1)

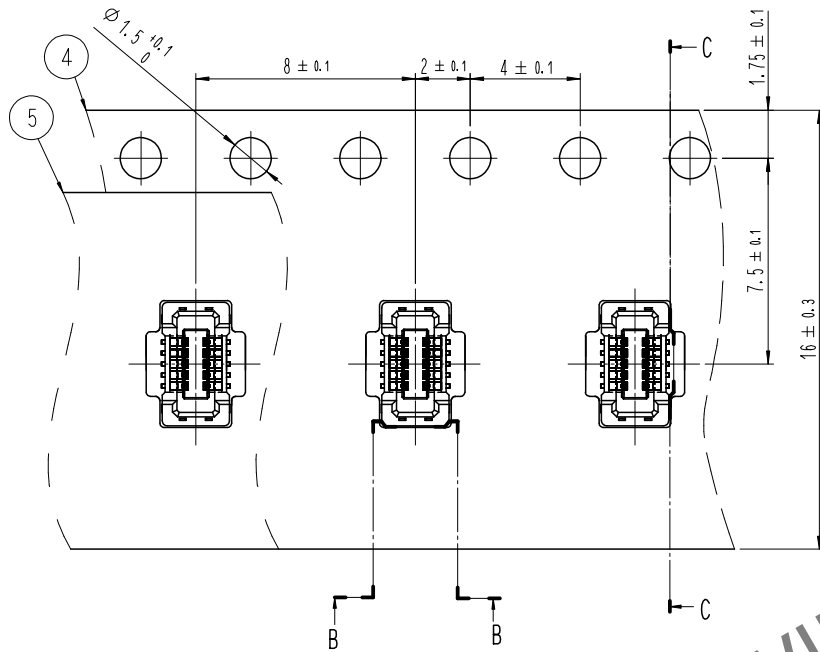


ENGAGEMENT FIGURE (50:1)

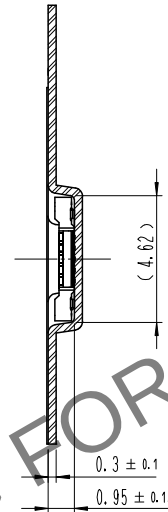


3	COPPER ALLOY	③	6	PS	BLACK (PLASTIC REEL)		
2	COPPER ALLOY	②	5	POLYESTER	CLEAR (COVER TAPE)		
1	LCP	UL94 V-0, BLACK	4	PS	CLEAR (EMBOSSED CARRIER TAPE)		
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS		
REMARKS			DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
			S. H. JUNG 16. 11. 23	S. H. JUNG 16. 11. 23	H. W. JO 16. 11. 23	T. S. KANG 16. 11. 23	19. 10. 30
CODE NO. (OLD)		DRAWING NO.  EDC3-632682-80		PART NO. KN13C0. 7-10DS-0. 4V(800)			
	SCALE 10:1	 HIROSE KOREA CO., LTD.	CODE NO	 CL 6647-0042-3-800			1/2
UNITS "							

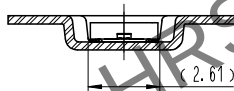
EMBOSED CARRIER TAPE PACKAGING (5:1)



C-C (5:1)



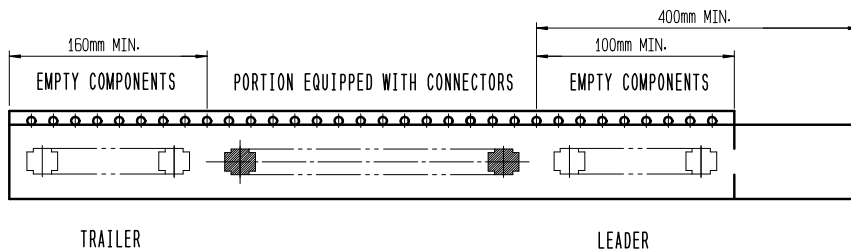
B-B (5:1)



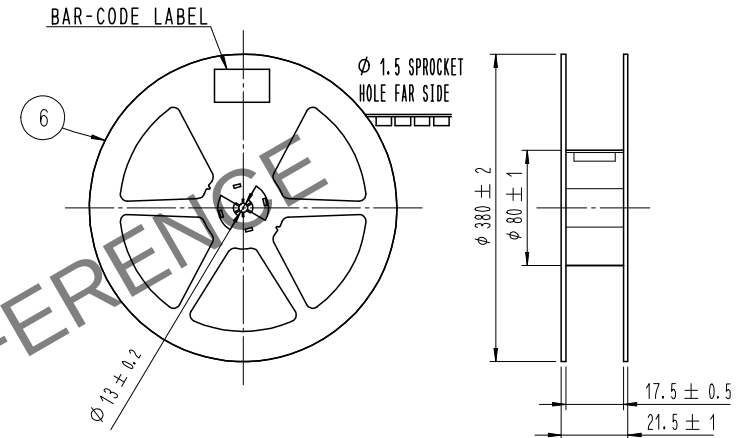
DIRECTION OF UNREELING



TAPING(FREE)



STYLE AND DIMENSION OF REEL (FREE)



DETAIL OF PART No. LABEL

LOT NO.	*****-**-**-**
CL NO.	CL ***-*****
PRODUCT	PART NO KN13C0.7-10DS-0.4V(800)
QUANTITY	Q'TY 8,000 PCS
SUPPLIER	HIROSE KOREA CO., Ltd.

RoHS H/F [®]	

5 . PER REEL 8,000 CONNECTORS.

6 . THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

7 REFER TO JIS C 0806, IEC-60286-3 (PACKAGING OF COMPONENTS FOR AUTOMATIC HANDLING)

DRAWING NO.	EDC3-632682-80	PART NO.	KN13C0.7-10DS-0.4V(800)
SCALE	10:1	CODE NO	CL 6647-0041-0-800
UNITS	mm		
HIROSE KOREA CO., LTD.			